

PRODUCTION DATA SHEET

DESCRIPTION

The LX6433 is a precise voltage monitor programmed to signal a low supply line condition. VMON is connected to the "monitored" supply line, when VMON drops below the threshold of 1.085V, RESET line goes low. When power is restored and VMON moves above the threshold voltage, RESET remains low for an additional 100ms to ensure system reset is fully applied.

Digital filtering inside the LX6433 ignores temporary dips in the VMON line lasting for less than 10uS to

avoid false triggering.

The monitor operates over a supply range (VIN) of 3V to 6V. The RESET line is capable of sinking an output load current of 1mA. This line is protected from short circuit to VIN or Ground without damage.

Tight threshold detection allows for a 1.085V to 1.125V window over temperature. System efficiency is maintained with ultra low IQ of 20µA.

The 5 pin SOT-23 package provides a small form factor similar to industry standard device types in this category. This package is RoHS compliant allowing Pb free PCB assembly.

IMPORTANT: For the most current data, consult MICROSEMI's website: http://www.microsemi.com

KEY FEATURES

- Precise Threshold Detection 1.105V ±0.02V
- 3V to 6.0V Operating Range
- Active Low RESET, Sink Current > 1mA
- **RESET Pulse Duration** Controlled, typical 100mS
- Quiescent Current < 40μA
- Wide Temperature: 0-85°C
- No External Components Required
- SOT-23, 5-Pin Package, RoHS Compliant (Pb-Free)
- Similar Devices: FM803, NCP803 and LM3724

APPLICATIONS/BENEFITS

- Portable Microprocessor Core Voltage Supply Monitor
- Supply Monitoring: 1.2V, 2.5V. 3.3V. 5V or any other level.

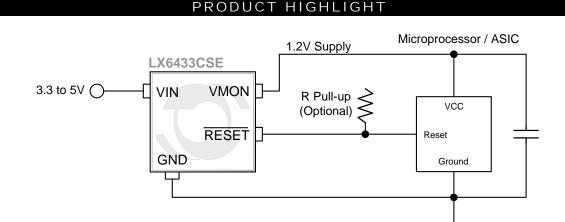
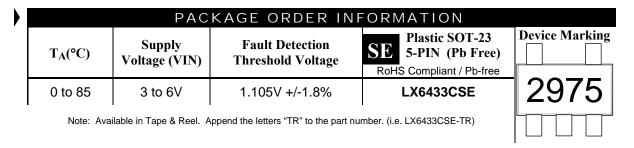


Figure 1 – LX6433 Typical Application Circuit





PRODUCTION DATA SHEET

ABSOLUTE MAXIMUM RATINGS

Input Voltage (IN)	0.3 V to 7.0 V
Monitor (VMON)	
RESET to GND	
Operating Temperature Range	40°C to +125°C
Storage Temperature Range, T _A	65°C to 150°C
Maximum Junction Temperature	150°C
RoHS / Pb-free Peak Package Solder Reflow Temperature	
(40 seconds maximum exposure)	260°C (+0 -5)

Note: Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground. Currents are positive into, negative out of specified terminal.

GND 1 5 VIN N.C. 2 RESET 3 4 VMON SE PACKAGE (Top View) ROHS / Pb-free 100% Matte Tin Pin Finish

THERMAL DATA

SE Plastic SOT-23 5-Pin

THERMAL RESISTANCE-JUNCTION TO AMBIENT, θ_{JA}

300°C/W

Junction Temperature Calculation: $T_J = T_A + (P_D \times \theta_{JA})$.

The $\theta_{\rm JA}$ numbers are guidelines for the thermal performance of the device/pc-board system. All of the above assume no ambient airflow.

•	FUNCTIONAL PIN DESCRIPTION				
	NAME DESCRIPTION				
	VIN	Supply voltage, Operational From 3.0V to 6.0V.			
	VMON Monitored input of 1.2V supply.				
	GND	Circuit ground.			
	RESET	Output pin, low level indicates fault mode.			

ELECTRICAL CHARACTERISTICS

Specifications apply over the ambient temperature of: $0^{\circ}\text{C} \le T \le 85^{\circ}\text{C}$ for $V_{\text{IN}} = 5V$ (except where otherwise noted). Typical values are at $T_A = 25^{\circ}\text{C}$.

	Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
•	Operating Range	perating Range VINoP Functional operation (correct logic state for RESET)		3.0		6.0	V
	Reset High	VMON _{TH+}	VMON rising, RESET = high (after timeout cycle is completed)	1.085			V
	Reset Low	VMON _{TH-}	VMON falling, RESET = low			1.125	V
	RESET Pulse Duration	RESET PW	Time RESET remains low after VMON rises above the threshold	50	100	150	mS
	Quiescent Current (Ground Pin)	ΙQ	RESET Open			40	μA
_	VMON Transient Filter	VMON TRANSIENT	RESET unchanged for VMON drop below VMON _{TH-}			10	μS
	VIVION Transient Filter	VMON TRIGGER PW	RESET activated for momentary dip in VMON below VMON _{TH-}	5			μS
	RESET VOUT LOW	V _{OL}	$I_{SINK} = 10$ mA, $V_{IN} = 5$ V ± 10%		.05	0.4	V
	RESET VOUT LOW	V _{OL}	I _{SINK} = 20mA, V _{IN} = 5V ±10% T _A 0°C to 70°C		.05	0.4	V
	RESET Leakage	I _{LKG}	VMON > 1.2V, V _{RESET} = 5V		.02	1	μA
	RESET DELAY after Trigger	T _{DELAY}	Time from VMON falling below threshold to RESET going low, VMON overdrive of 50mV.			11	μS



PRODUCTION DATA SHEET

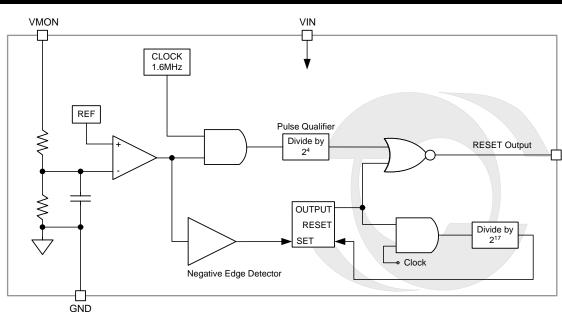
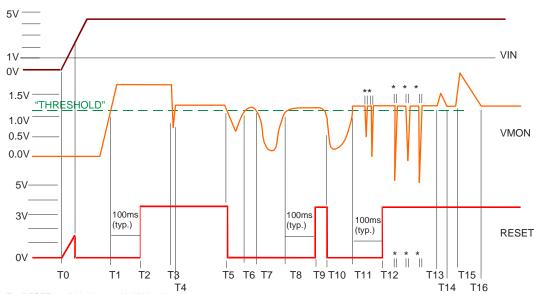


Figure 2 - Simplified Block Diagram



T0: RESET invalid logic state for VIN < 2V

T1-T1 Vmonitor exceeds Threshold, at T1, RESET pulse remains low for 100ms until T2.

T3 - T4: Transient on VIN is ignored, less than 10usec duration for Vmonitor < THRESHOLD. (Same applies for *)

T5: Vmonitor drops below Threshold, remains low for > 10usec which activates RESET Low.

T6: Vmonitor rises above Threshold but previous fault at T5 has not cycled through full timeout (T 6-T7 < 50mS), RESET remains low.

T7: Vmonitor fals below Threshold, RESET remains low.

T7-T8 duration > 10uS, RESET timer restarted for 100mS timeout

T8-T9: Duration exceeds 150ms, RESET timer cycle completed, output rises

T10-T11: Vmonitor falls below Threshold for > 10uS, RESET signal goes low.

T13-T14, T15-T16: Vmonitor is above Threshold, no limits apply for peak voltage or duration.

Figure 3 - Timing Diagram



PRODUCTION DATA SHEET

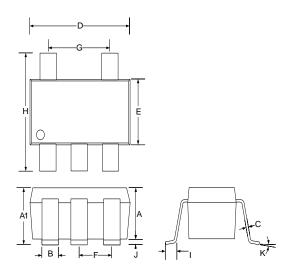
FUNCTIONAL

The LX6433 operates as a power supply monitor with a As VMON ramps upwards from zero, RESET is held VIN is the power source for the IC. The RESET pin is an open drain, with active low logic. An external pulldoes not provide this feature.

threshold window of 1.085V to 1.125V (±1.8%) that low until VMON exceeds the threshold, this starts an can be programmable using external resistors. The internal 100ms timer which continues to hold RESET VMON pin is the input to the internal comparator and low for that interval. As long as VMON remains above the threshold level and the 100ms timer has completed the cycle, RESET remains high (high impedance state). up resistor can be used if the device (ASIC) driven If a transient of less than 10uS interrupts VMON causing a drop below the threshold the LX6433 will ignore the event. If VMON does drop below the threshold for greater than 12uS the RESET will remain low until VMON recovers above the threshold and the RESET time pulse has been timed out (100ms).

PACKAGE DIMENSIONS

5 Pin Plastic SOT-23



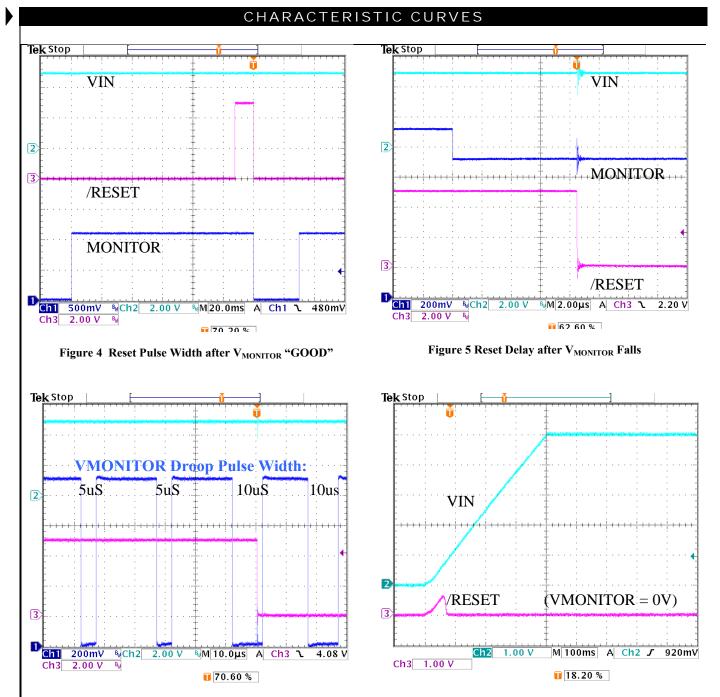
	MILLIMETERS		Inc	HES
Dim	MIN	MAX	MIN	MAX
Α	0.90	1.30	0.035	0.051
A1	0.90	1.45	0.035	0.057
В	0.25	0.50	0.010	0.020
С	0.09	0.20	0.004	0.008
D	2.80	3.10	0.110	0.122
Е	1.50	1.75	0.059	0.069
F	0.95 BSC		0.038 BSC	
G	1.90 BSC		0.075	BSC
Н	2.60	3.00	0.102	0.118
I	0.35	0.55	0.014	0.022
J	0.00	0.15	0.000	0.006
K	10° MAX		10° MAX	

Note:

- 1. Controlled dimensions are in mm, inches are for reference only.
- 2. Dimensions do not include mold flash or protrusions; these shall not exceed 0.155mm (.006") on any side. Lead dimension shall not include solder coverage



PRODUCTION DATA SHEET





LX6433

Precision Voltage Monitor

PRODUCTION DATA SHEET

NOTES

PRODUCTION DATA – Information contained in this document is proprietary to Microsemi and is current as of publication date. This document may not be modified in any way without the express written consent of Microsemi. Product processing does not necessarily include testing of all parameters. Microsemi reserves the right to change the configuration and performance of the product and to discontinue product at any time.